

(1.00 mm) .0394"

PCIE-036-02-F-D-TH **PCIE SERIES**

PCI EXPRESS® CARD SOCK

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?PCIE

Insulator Material:

-TH=Black Nylon -EMS2 & -RA=LCP Contact:

Phosphor Bronze

Plating: Au or Sn over 50 µ" (1.27 µm) Ni Current Rating: 2.2 A per pin

(2 adjacent pins powered)
Operating Temp:
-55 °C to +125 °C Card Insertion Depth: (7.65 mm) .301" nominal

RoHS Compliant:

Lead-Free Solderable: -RA & -EMS2=Yes -TH=Wave only

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



OTHER SOLUTIONS

PCI Express® Jumpers & Extenders call for PCIEC Series



- · Loop back Extender (From one PCIe® slot to another PCIe® slot)
- Ser-Des Physical Extender (From one PCIe® slot to another PCIe® Ser-Des)
- Physical Extender for easy troubleshooting of PCIe® card debug and analysis (PCIe® slot to Emulator or Analyzer)

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Some lengths, styles and options are non-standard, non-returnable.

Card Mates:

1.60 mm) .062" card

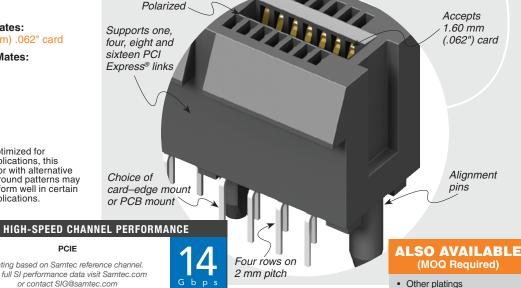
Cable Mates:

Note: While optimized for 50 Ω applications, this connector with alternative signal/ground patterns may also perform well in certain 75 Ω applications.

PCIE

(2.05)

.081 DIA



Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

PLATING OPTION

TAIL OPTION

-036, -064, -098, -164

B2-<u>0000000000</u> A2 -→ (1.00) .03937 (1.78) .070 -(11.00) (2.31).433 .091 (15.40) .606 (10.00)

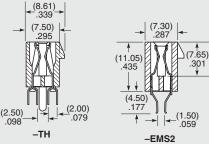
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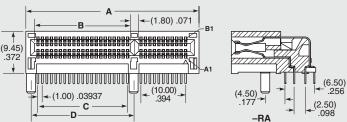
POSITIONS

–F = Gold flash on contact, Tin on tail

-EMS2 = Edge Mount _TH = Through-hole

-RA = Right-angle





POSITIONS Α В С D (25.00)(7.65) .301 (6.00) .236 (9.15) .360 -036 (X1) .984 (39.00) (21.65) (20.00) (23.15) -064 (X4) 1.535 .852 .787 .911 (56.00) 2.205 (38.65) 1.522 (40.15) 1.581 (37.00)-098 (X8) (71.65) 2.821 (70.00) (89.00) (73.15) -164 (X16)